

LM338-MIL 5-Amp Adjustable Regulators

1 Features

- Specified 7-A Peak Output Current
- Specified 5-A Output Current
- Adjustable Output Down to 1.2 V
- Specified Thermal Regulation
- Current Limit Constant With Temperature
- P⁺ Product Enhancement Tested
- Output is Short-Circuit Protected

2 Applications

- Adjustable Power Supplies
- Constant Current Regulators
- Battery Chargers

3 Description

The LM338-MIL series of adjustable 3-terminal positive voltage regulators is capable of supplying in excess of 5 A over a 1.2-V to 32-V output range. They are exceptionally easy to use and require only 2 resistors to set the output voltage. Careful circuit design has resulted in outstanding load and line regulation, comparable to many commercial power supplies. The LM338-MIL family is supplied in a standard 3-lead transistor package.

A unique feature of the LM338-MIL family is time-dependent current limiting. The current limit circuitry allows peak currents of up to 12 A to be drawn from the regulator for short periods of time. This allows the LM338-MIL to be used with heavy transient loads and speeds start-up under full-load conditions. Under sustained loading conditions, the current limit decreases to a safe value protecting the regulator. Also included on the chip are thermal overload protection and safe area protection for the power transistor. Overload protection remains functional even if the adjustment (ADJ) pin is accidentally disconnected.

Normally, no capacitors are needed unless the device is situated more than 6 inches from the input filter capacitors in which case an input bypass is needed. An output capacitor can be added to improve transient response, while bypassing the adjustment pin increases the ripple rejection of the regulator.

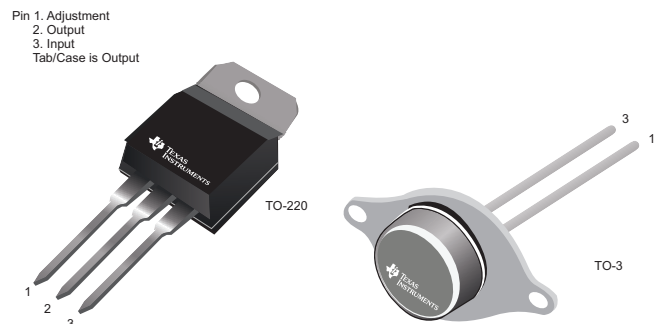
Besides replacing fixed regulators or discrete designs, the LM338-MIL is useful in a wide variety of other applications. Because the regulator is floating and receives only the input-to-output differential voltage, supplies of several hundred volts can be regulated as long as the maximum input to output differential is not exceeded; do not short-circuit output to ground. The part numbers in the LM338-MIL series which have a *K* suffix are packaged in a standard steel TO-CAN package, while those with a *T* suffix are packaged in a TO-220 plastic package. The LM338-MIL is rated for $T_J = -55^{\circ}\text{C}$ to 150°C , and the LM338-MIL is rated for $T_J = 0^{\circ}\text{C}$ to 125°C .

Device Information⁽¹⁾

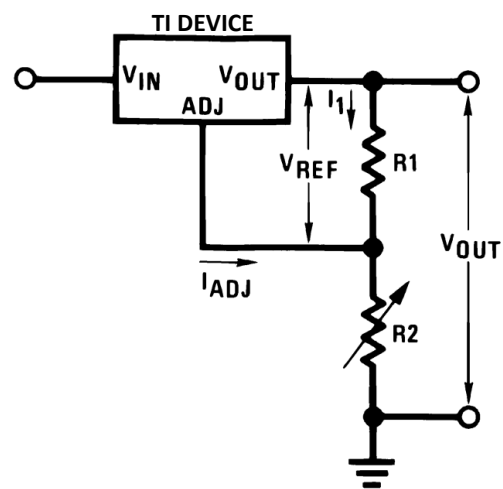
| PART NUMBER | PACKAGE | BODY SIZE (NOM) |
|-------------|------------|----------------------|
| LM338-MIL | TO-220 (3) | 10.16 mm × 14.986 mm |
| | TO-CAN (2) | 25.40 mm × 38.94 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Available Packages



Typical Application Circuit



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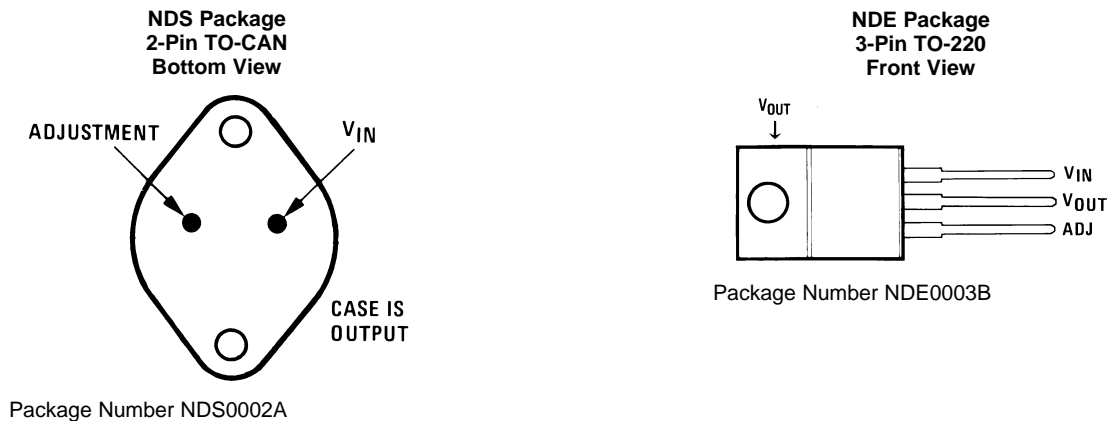
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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| DATE | REVISION | NOTES |
|-----------|----------|------------------|
| June 2017 | * | Initial release. |

5 Pin Configuration and Functions



Pin Functions

| PIN | | | I/O | DESCRIPTION |
|-----------|--------|--------|-----|---|
| NAME | TO-220 | TO-CAN | | |
| ADJ | 1 | 1 | I | Output voltage adjustment pin. Connect to a resistor divider to set V_O |
| V_{IN} | 3 | 2 | I | Supply input pin |
| V_{OUT} | 2 | Case | O | Voltage output pin |

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | MIN | MAX | UNIT |
|---------------------------------------|---------------------------------|-----|------|
| Input and output voltage differential | -0.3 | 40 | V |
| Power dissipation | Internally limited | | |
| Lead temperature | TO-3 package (soldering, 10 s) | | °C |
| | TO-220 package (soldering, 4 s) | | |
| Operating temperature, T_J | 0 | 125 | °C |
| Storage temperature, T_{stg} | -65 | 150 | °C |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| | MIN | MAX | UNIT |
|--------------------------------------|-----|-----|------|
| Input-to-output voltage differential | 3 | 40 | V |
| Output current | | 5 | A |

6.3 Thermal Information

| THERMAL METRIC ⁽¹⁾ | | LM338 | | UNIT |
|-------------------------------|--|--------------|--------------|------|
| | | NDE (TO-220) | NDS (TO-CAN) | |
| | | 3 PINS | 2 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 22.9 | 35 | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

Thermal Information (continued)

| THERMAL METRIC ⁽¹⁾ | | LM338 | | UNIT |
|-------------------------------|--|--------------|--------------|------|
| | | NDE (TO-220) | NDS (TO-CAN) | |
| | | 3 PINS | 2 PINS | |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance | 15.7 | 1 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 4.1 | — | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter | 2.1 | — | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 4.1 | — | °C/W |
| $R_{\theta JC(bot)}$ | Junction-to-case (bottom) thermal resistance | 0.7 | — | °C/W |

6.4 Electrical Characteristics

Values apply for $T_J = 25^\circ\text{C}$; $V_{IN} - V_{OUT} = 5\text{ V}$; and $I_{OUT} = 10\text{ mA}$ (unless otherwise noted).⁽¹⁾

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT | |
|----------------------------|---|--|--|--------|--------|---------------|---|
| V_{REF} | Reference voltage | $3\text{ V} \leq (V_{IN} - V_{OUT}) \leq 35\text{ V}$, $10\text{ mA} \leq I_{OUT} \leq 5\text{ A}$, $P \leq 50\text{ W}$, $T_J = 0^\circ\text{C}$ to 125°C | 1.19 | 1.24 | 1.29 | V | |
| V_{RLINE} | Line regulation | $3\text{ V} \leq (V_{IN} - V_{OUT}) \leq 35\text{ V}^{(2)}$ | $T_J = 25^\circ\text{C}$ | | 0.005% | 0.03% | V |
| | | | $T_J = 0^\circ\text{C}$ to 125°C | | 0.02% | 0.06% | V |
| V_{RLOAD} | Load regulation | $10\text{ mA} \leq I_{OUT} \leq 5\text{ A}^{(2)}$ | $T_J = 25^\circ\text{C}$ | | 0.1 | 0.5 | |
| | | | $T_J = 0^\circ\text{C}$ to 125°C | | 0.3 | 1 | |
| | Thermal regulation | 20-ms pulse | | 0.002% | 0.02% | W | |
| I_{ADJ} | Adjustment pin current | $T_J = 0^\circ\text{C}$ to 125°C | | 45 | 100 | μA | |
| ΔI_{ADJ} | Adjustment pin current change | $10\text{ mA} \leq I_{OUT} \leq 5\text{ A}$, $3\text{ V} \leq (V_{IN} - V_{OUT}) \leq 35\text{ V}$, $T_J = 0^\circ\text{C}$ to 125°C | | 0.2 | 5 | μA | |
| ΔV_{RT} | Temperature stability | $T_J = 0^\circ\text{C}$ to 125°C | | 1 | | | |
| $I_{LOAD(MIN)}$ | Minimum load current | $V_{IN} - V_{OUT} = 35\text{ V}$, $T_J = 0^\circ\text{C}$ to 125°C | | 3.5 | 10 | mA | |
| I_{CL} | Current limit | $V_{IN} - V_{OUT} \leq 10\text{ V}$ | | | | | |
| | | DC, $T_J = 0^\circ\text{C}$ to 125°C | 5 | 8 | | A | |
| | | 0.5-ms peak, $T_J = 0^\circ\text{C}$ to 125°C | 7 | 12 | | A | |
| | | $V_{IN} - V_{OUT} = 30\text{ V}$ | | | 1 | A | |
| V_N | RMS output noise (percent of V_{OUT}) | $10\text{ Hz} \leq f \leq 10\text{ kHz}$ | | 0.003% | | | |
| $\Delta V_R/\Delta V_{IN}$ | Ripple rejection ratio | $V_{OUT} = 10\text{ V}$, $f = 120\text{ Hz}$, $C_{ADJ} = 0\text{ }\mu\text{F}$, $T_J = 0^\circ\text{C}$ to 125°C | | 60 | | dB | |
| | | $V_{OUT} = 10\text{ V}$, $f = 120\text{ Hz}$, $C_{ADJ} = 10\text{ }\mu\text{F}$, $T_J = 0^\circ\text{C}$ to 125°C | 60 | 75 | | dB | |
| | Long-term stability | $T_J = 125^\circ\text{C}$, 1000 Hrs | | 0.3% | 1% | | |

- (1) These specifications are applicable for power dissipations up to 50 W for the TO-3 (NDS) package and 25 W for the TO-220 (NDE) package. Power dissipation is specified at these values up to 15-V input-output differential. Above 15-V differential, power dissipation is limited by internal protection circuitry. All limits (that is, the numbers in the minimum and maximum columns) are specified to TI's AOQL (Average Outgoing Quality Level).
- (2) Regulation is measured at a constant junction temperature, using pulse testing with a low duty cycle. Changes in output voltage due to heating effects are covered under the specifications for thermal regulation.

6.5 Typical Characteristics

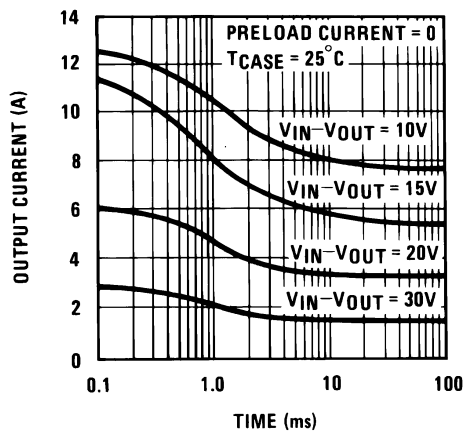


Figure 1. Current Limit

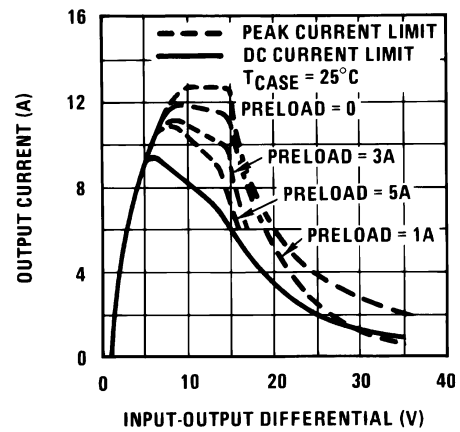


Figure 2. Current Limit

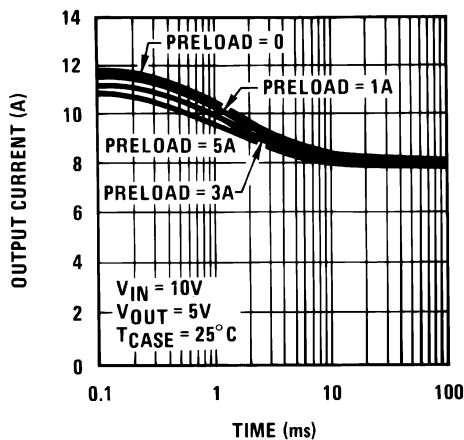


Figure 3. Current Limit

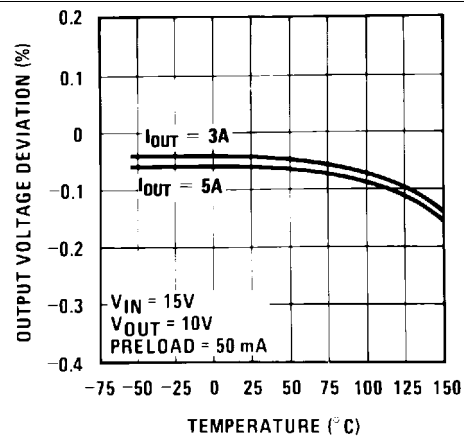


Figure 4. Load Regulation

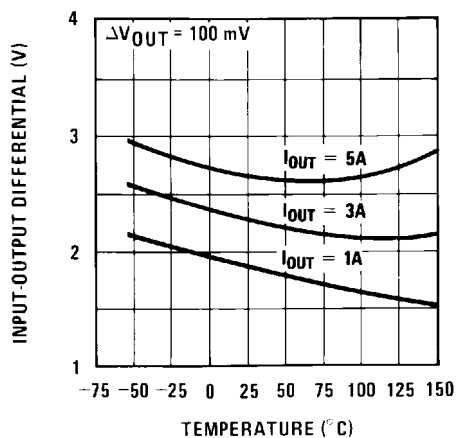


Figure 5. Dropout Voltage

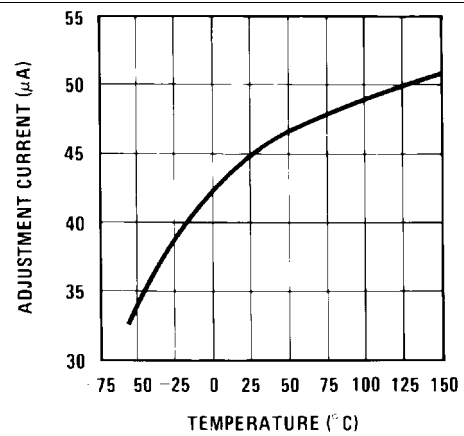


Figure 6. Adjustment Current

Typical Characteristics (continued)

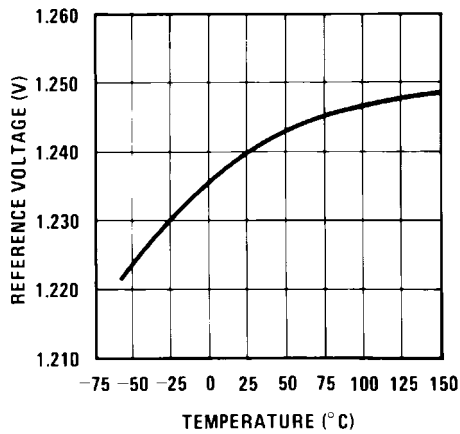


Figure 7. Temperature Stability

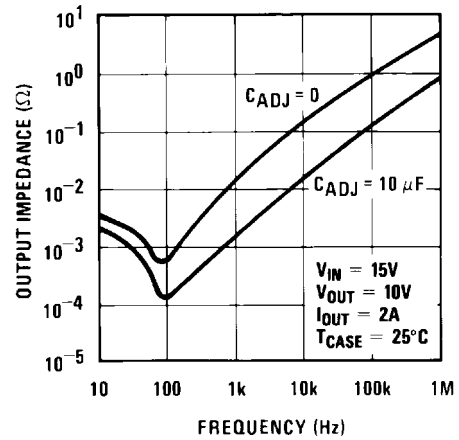


Figure 8. Output Impedance

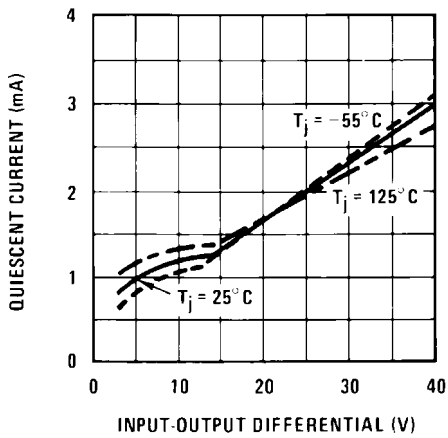


Figure 9. Minimum Operating Current

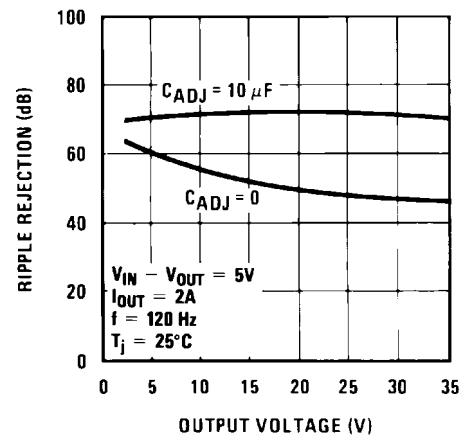


Figure 10. Ripple Rejection

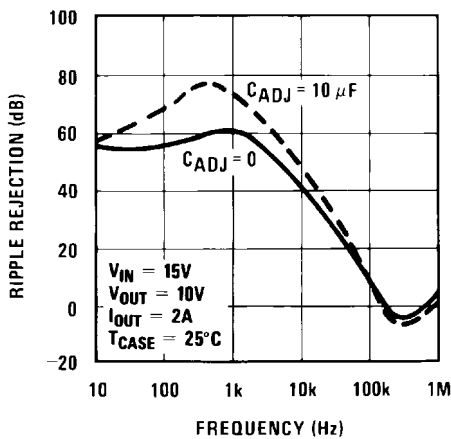


Figure 11. Ripple Rejection

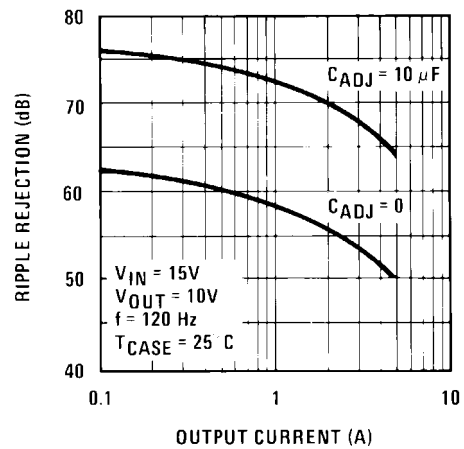
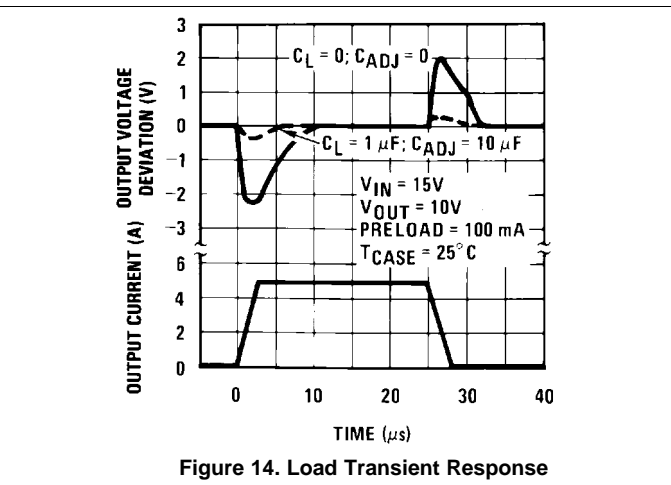
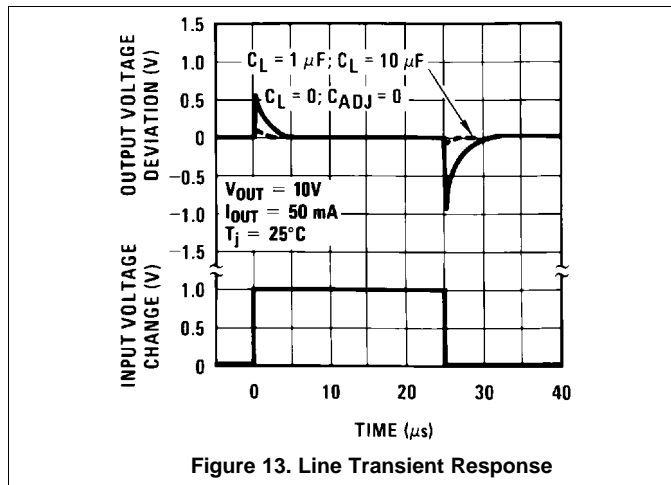


Figure 12. Ripple Rejection

Typical Characteristics (continued)



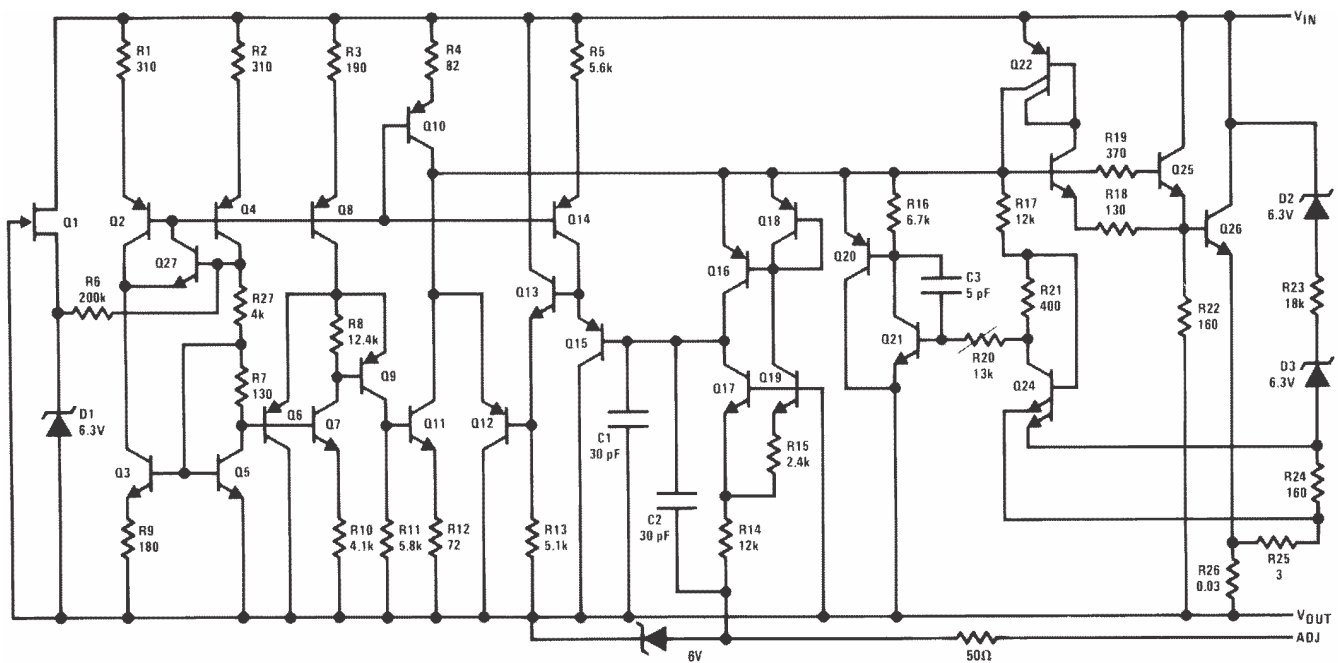
7 Detailed Description

7.1 Overview

The LM338 device is an adjustable, three-terminal, positive-voltage regulator capable of supplying more than 5 A over an output-voltage range of 1.2 V to 32 V. It requires only two external resistors to set the output voltage. The device features a typical line regulation of 0.005% and typical load regulation of 0.1%. It includes time-dependent current limiting, thermal overload protection, and safe operating area protection. Overload protection remains functional even if the ADJUST terminal is disconnected.

The LM338 device is versatile in its applications, including uses in programmable output regulation and local on-card regulation. Or, by connecting a fixed resistor between the ADJUST and OUTPUT terminals, the LM338 device can function as a precision current regulator. An optional output capacitor can be added to improve transient response. The ADJUST terminal can be bypassed to achieve very high ripple-rejection ratios, which are difficult to achieve with standard three-terminal regulators.

7.2 Functional Block Diagram



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7.3 Feature Description

7.3.1 NPN Darlington Output Drive

NPN Darlington output topology provides naturally low output impedance and an output capacitor is optional. To support maximum current and lowest temperature, 3-V headroom is recommended ($V_I - V_O$).

7.3.2 Overload Block

Overcurrent and overtemperature shutdown protects the device against overload or damage from operating in excessive heat.

7.3.3 Programmable Feedback

Op amp with 1.25-V offset input at the ADJUST terminal provides easy output voltage or current (not both) programming. For current regulation applications, a single resistor whose resistance value is $1.25 V_{IO}$ and power rating is greater than $1.25 V^2/R$ must be used. For voltage regulation applications, two resistors set the output voltage.

7.4 Device Functional Modes

7.4.1 Normal Operation

The device OUTPUT pin sources current necessary to make OUTPUT pin 1.25 V greater than ADJUST terminal to provide output regulation.

7.4.2 Operation With Low Input Voltage

The device requires up to 3-V headroom ($V_I - V_O$) to operate in regulation. With less headroom, the device may drop out and OUTPUT voltage is INPUT voltage minus drop out voltage.

7.4.3 Operation at Light Loads

The device passes its bias current to the OUTPUT pin. The load or feedback must consume this minimum current for regulation or the output may be too high. A 250- Ω feedback resistor between OUTPUT and ADJUST consumes the worst case minimum load current of 5 mA.

7.4.4 Operation in Self Protection

When an overload occurs, the device shuts down Darlington NPN output stage or reduces the output current to prevent device damage. The device automatically resets from the overload. The output may be reduced or alternate between on and off until the overload is removed.

8 Application and Implementation

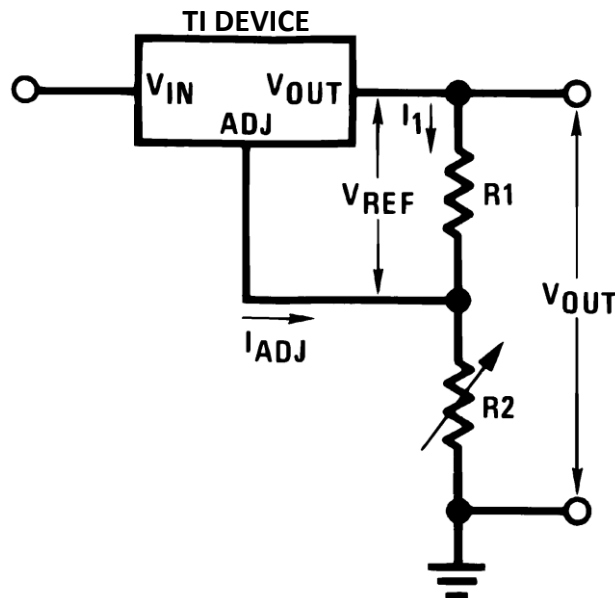
NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

In operation, the LM338-MIL develops a nominal 1.25-V reference voltage (V_{REF}) between the output and adjustment terminal. The reference voltage is impressed across program resistor R_1 and, since the voltage is constant, a constant current I_1 then flows through the output set resistor R_2 , giving an output voltage calculated with Equation 1.

$$V_{OUT} = V_{REF} \left(1 + \frac{R_2}{R_1} \right) + I_{ADJ} R_2 \quad (1)$$



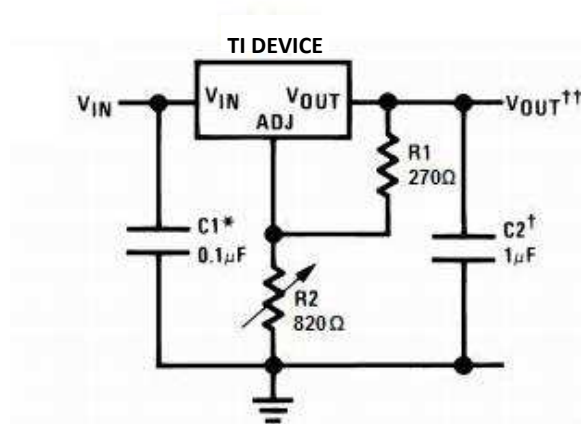
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Figure 15. Typical Application Circuit

Because the 50- μ A current from the adjustment terminal represents an error term, the LM338-MIL was designed to minimize I_{ADJ} and make it very constant with line and load changes. To do this, all quiescent operating current is returned to the output establishing a minimum load current requirement. If there is insufficient load on the output, the output rises.

8.2 Typical Applications

8.2.1 Constant 5-V Regulator



*Needed if device is more than 6 inches from filter capacitors.

†Optional—improves transient response

$$V_{OUT}^{\dagger\dagger} = 1.25 \text{ V} \left(1 + \frac{R_2}{R_1} \right) + I_{ADJ} (R_2)$$

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Figure 16. Constant 5-V Regulator

8.2.1.1 Design Requirements

R1: Because the LM338-MIL produces a typical 1.24 V potential between the OUTPUT and ADJUST pins, placing a 270-Ω resistor between them causes 4.6 mA to flow through R1 and R2.

R2: To achieve a 5-V output, the sum of the voltages across R1 and R2 must equal 5 V. Therefore, Vr2 must equal 3.76 V when 4.6 mA is flowing through it. $R_2 = V_{r2} / I = 3.76 \text{ V} / 4.6 \text{ mA} = \sim 820 \Omega$.

C_{IN}: 0.1 μF of input capacitance helps filter out unwanted noise, especially if the regulator is located far from the power supply filter capacitors.

C_{OUT}: The regulator is stable without any output capacitance, but adding a 1-μF capacitor improves the transient response.

C_{ADJ}: A 10-μF capacitor bypassing the ADJUST pin to ground improves the regulators ripple rejection.

D1: Protection diode D1 is recommended if C_{OUT} is used. The diode provides a low-impedance discharge path to prevent the capacitor from discharging into the output of the regulator (see [Protection Diodes](#)).

D2: Protection diode D2 is recommended if C_{ADJ} is used. The diode provides a low-impedance discharge path to prevent the capacitor from discharging into the output of the regulator (see [Protection Diodes](#)).

[Table 1](#) lists the design parameters for this typical application.

Table 1. Design Parameters

| PARAMETER | VALUE |
|--------------------------------------|--------------|
| Feedback resistor 1 (R1) | 270 Ω |
| Feedback resistor 2 (R2) | 820 Ω |
| Input capacitor (C _{IN}) | 0.1 μ F |
| Output capacitor (C _{OUT}) | 1 μ F |
| Adjust capacitor (C _{ADJ}) | 10 μ F |

8.2.1.2 Detailed Design Procedure

8.2.1.2.1 External Capacitors

An input bypass capacitor is recommended. A 0.1- μ F disc or 1- μ F solid tantalum on the input is suitable input bypassing for almost all applications. The device is more sensitive to the absence of input bypassing when adjustment or output capacitors are used but the above values eliminate the possibility of problems.

The adjustment terminal can be bypassed to ground on the LM338-MIL to improve ripple rejection. This bypass capacitor prevents ripple from being amplified as the output voltage is increased. With a 10- μ F bypass capacitor, 75-dB ripple rejection is obtainable at any output level. Increases over 20 μ F do not appreciably improve the ripple rejection at frequencies above 120 Hz. If the bypass capacitor is used, it is sometimes necessary to include protection diodes to prevent the capacitor from discharging through internal low current paths and damaging the device.

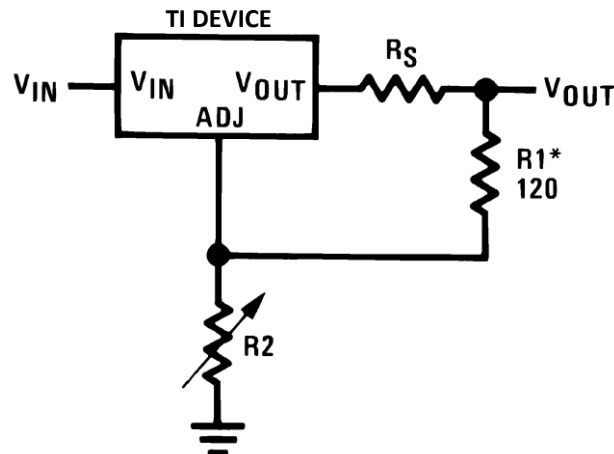
In general, the best type of capacitors to use are solid tantalum. Solid tantalum capacitors have low impedance even at high frequencies. Depending upon capacitor construction, it takes about 25 μ F in aluminum electrolytic to equal 1- μ F solid tantalum at high frequencies. Ceramic capacitors are also good at high frequencies; but some types have a large decrease in capacitance at frequencies around 0.5 MHz. For this reason, 0.01- μ F disc may seem to work better than a 0.1- μ F disc as a bypass.

Although the LM338-MIL is stable with no output capacitors, like any feedback circuit, certain values of external capacitance can cause excessive ringing. This occurs with values between 500 pF and 5000 pF. A 1- μ F solid tantalum (or 25- μ F aluminum electrolytic) on the output swamps this effect and insures stability.

8.2.1.2.2 Load Regulation

The LM338-MIL is capable of providing extremely good load regulation but a few precautions are needed to obtain maximum performance. The current set resistor connected between the adjustment terminal and the output terminal (usually 240 Ω) must be tied directly to the output of the regulator (case) rather than near the load. This eliminates line drops from appearing effectively in series with the reference and degrading regulation. For example, a 15-V regulator with 0.05- Ω resistance between the regulator and load has a load regulation due to line resistance of $0.05 \Omega \times I_L$. If the set resistor is connected near the load, the effective line resistance is 0.05 Ω (1 + R2/R1) or in this case, 11.5 times worse.

[Figure 17](#) shows the effect of resistance between the regulator and 240- Ω set resistor.



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Figure 17. Regulator With Line Resistance in Output Lead

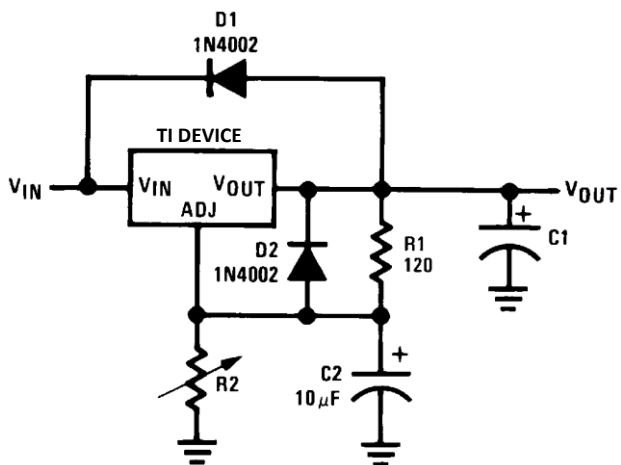
With the TO-3 package, it is easy to minimize the resistance from the case to the set resistor, by using 2 separate leads to the case. The ground of R2 can be returned near the ground of the load to provide remote ground sensing and improve load regulation.

8.2.1.2.3 Protection Diodes

When external capacitors are used with *any* IC regulator it is sometimes necessary to add protection diodes to prevent the capacitors from discharging through low current points into the regulator. Most 20- μ F capacitors have low enough internal series resistance to deliver 20-A spikes when shorted. Although the surge is short, there is enough energy to damage parts of the IC.

When an output capacitor is connected to a regulator and the input is shorted, the output capacitor discharges into the output of the regulator. The discharge current depends on the value of the capacitor, the output voltage of the regulator, and the rate of decrease of V_{IN} . In the LM338-MIL this discharge path is through a large junction that is able to sustain 25-A surge with no problem. This is not true of other types of positive regulators. For output capacitors of 100 μ F or less at output of 15 V or less, there is no need to use diodes.

The bypass capacitor on the adjustment terminal can discharge through a low current junction. Discharge occurs when *either* the input or output is shorted. Internal to the LM338-MIL is a 50- Ω resistor which limits the peak discharge current. No protection is needed for output voltages of 25-V or less and 10- μ F capacitance. [Figure 18](#) shows an LM338-MIL with protection diodes included for use with outputs greater than 25 V and high values of output capacitance.



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$$V_{OUT} = 1.25V \left(1 + \frac{R_2}{R_1} \right) + I_{ADJ}R_2$$

D1 protects against C1
D2 protects against C2

Figure 18. Regulator With Protection Diodes

8.2.1.3 Application Curves

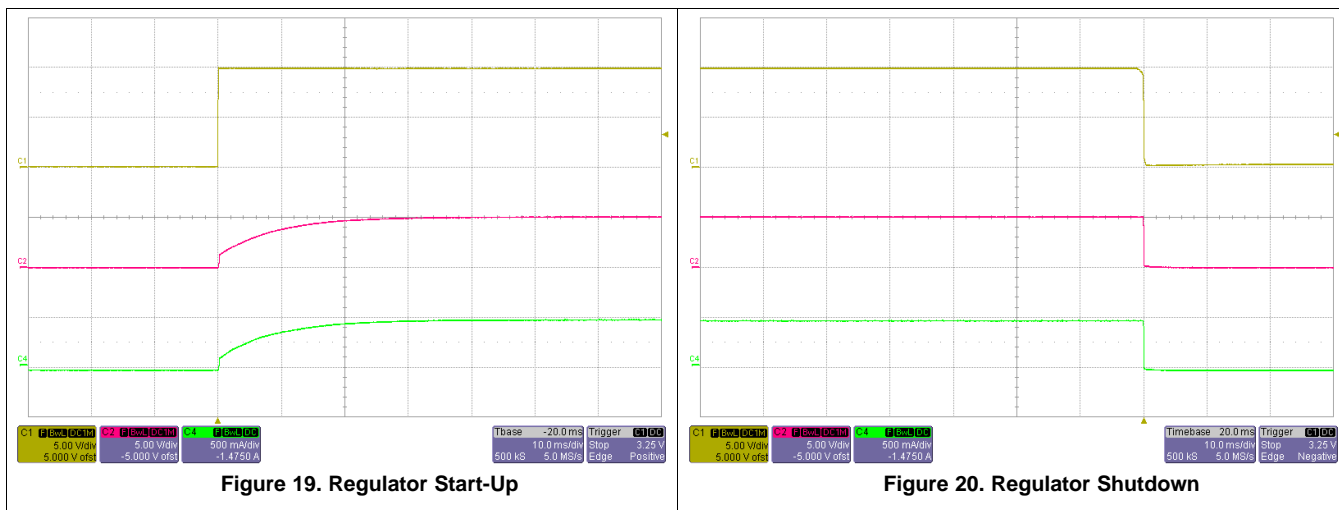
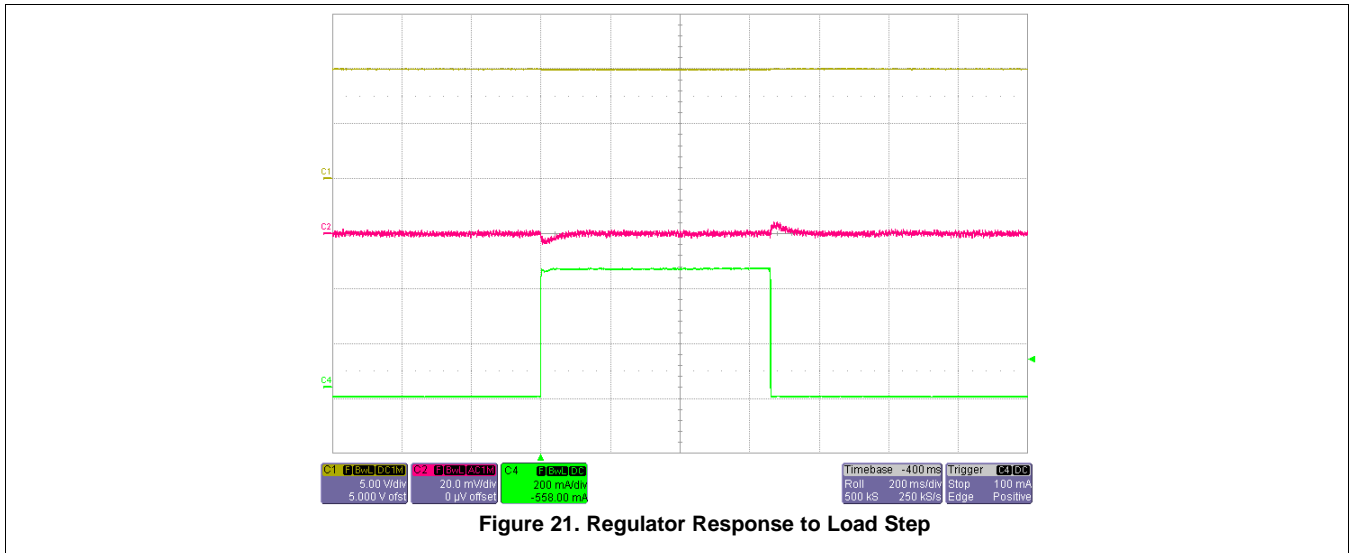
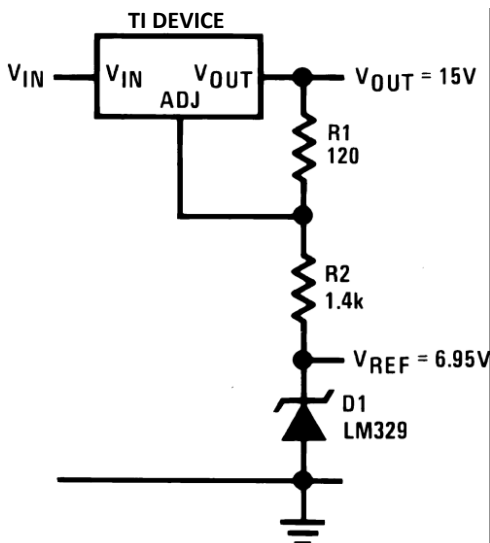


Figure 19. Regulator Start-Up

Figure 20. Regulator Shutdown

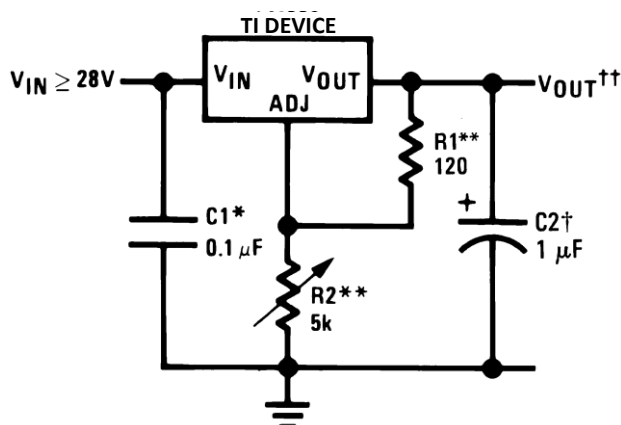


8.3 System Examples



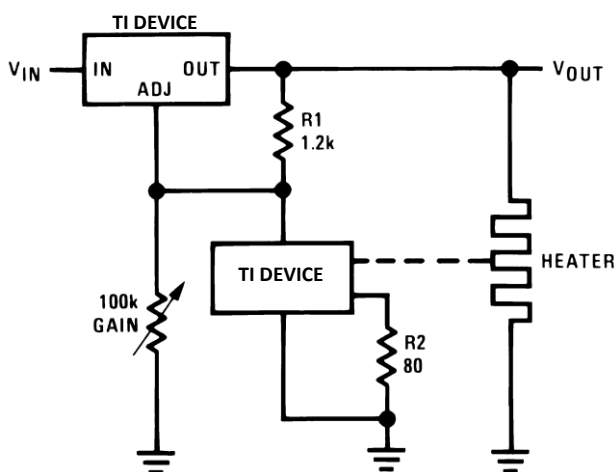
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Figure 22. Regulator and Voltage Reference



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Figure 23. 1.2-V to 25-V Adjustable Regulator



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Full output current not available at high input-output voltages
 †Optional—improves transient response. Output capacitors in the range of 1 μF to 1000 μF of aluminum or tantalum electrolytic are commonly used to provide improved output impedance and rejection of transients.

*Needed if device is more than 6 inches from filter capacitors.

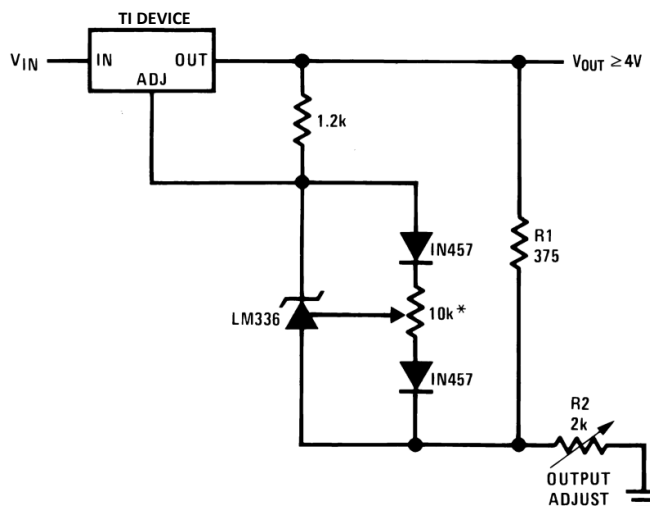
$$\dagger\dagger V_{OUT} = 1.25V \left(1 + \frac{R_2}{R_1} \right) + I_{ADJ}(R_2)$$

R1, R2 as an assembly can be ordered from Bourns:

MIL part no. 7105A-AT2-502

COMM part no. 7105A-AT7-502

Figure 24. Temperature Controller

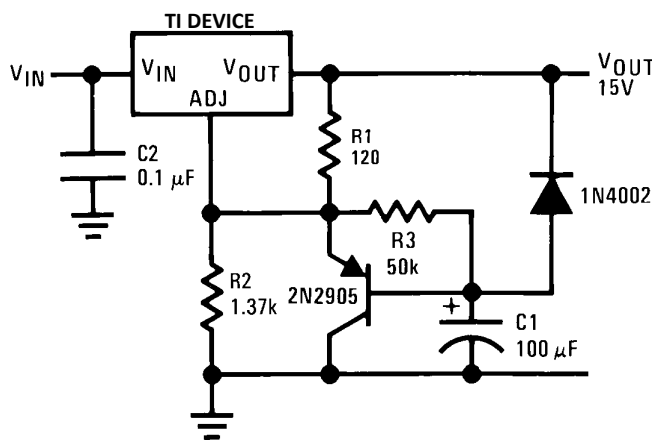


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* Adjust for 3.75 across R1

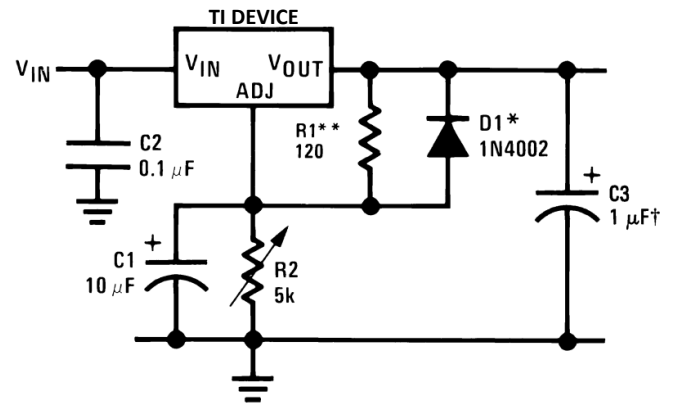
Figure 25. Precision Power Regulator With Low Temperature Coefficient

System Examples (continued)



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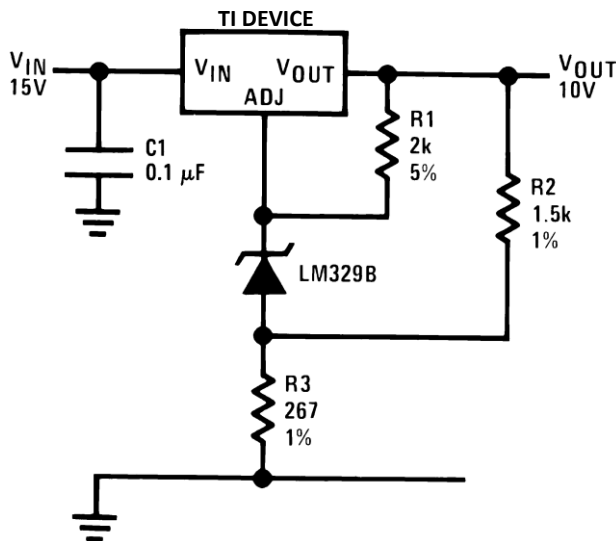
Figure 26. Slow Turnon 15-V Regulator



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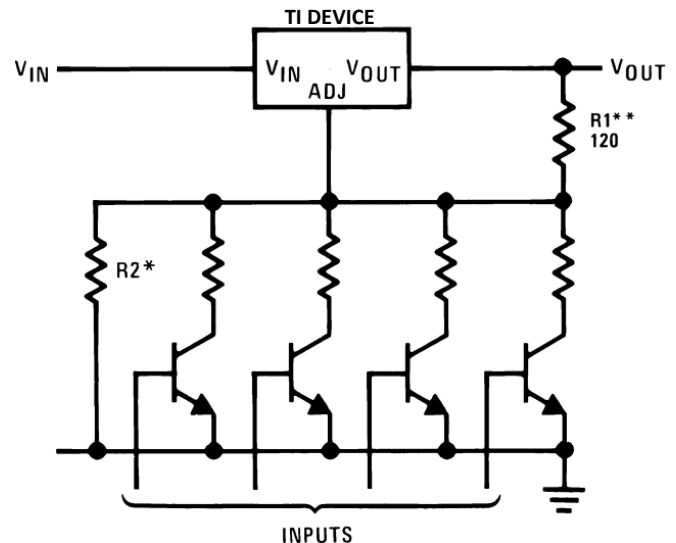
†Solid tantalum
*Discharges C1 if output is shorted to ground

Figure 27. Adjustable Regulator With Improved Ripple Rejection



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Figure 28. High Stability 10-V Regulator

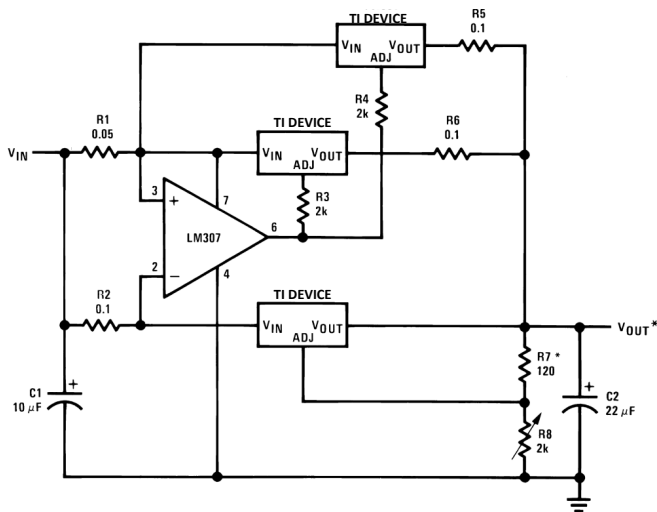


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*Sets maximum V_{OUT}

Figure 29. Digitally Selected Outputs

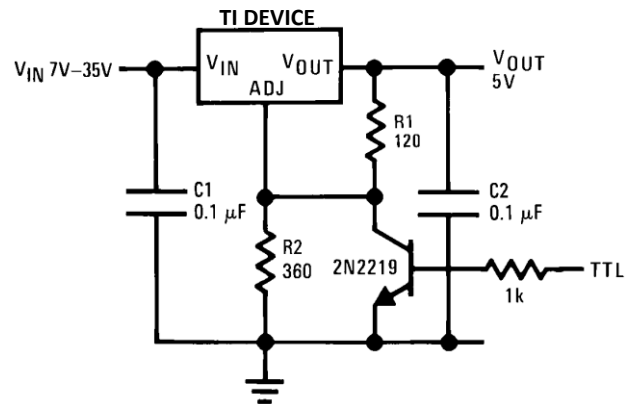
System Examples (continued)



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* Minimum load—100 mA

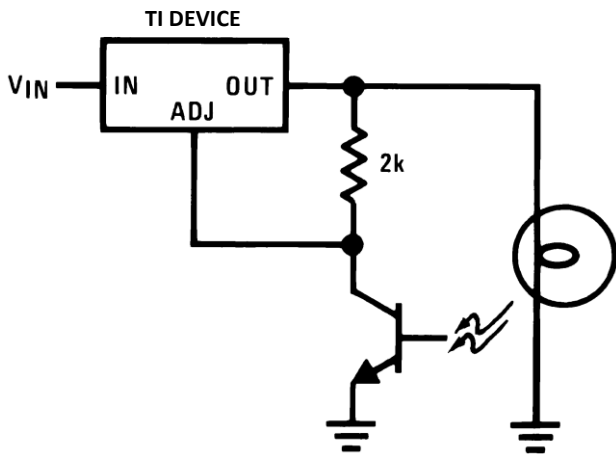
Figure 30. 15-A Regulator



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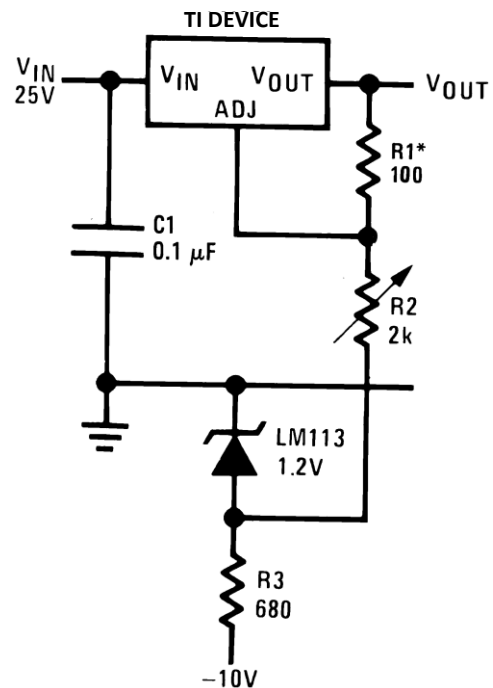
** Minimum output ≈ 1.2 V

Figure 31. 5-V Logic Regulator With Electronic Shutdown**



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Figure 32. Light Controller

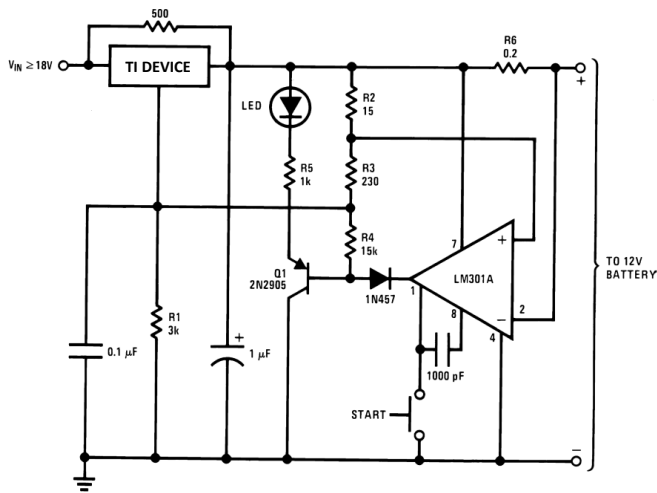


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Full output current not available at high input-output voltages

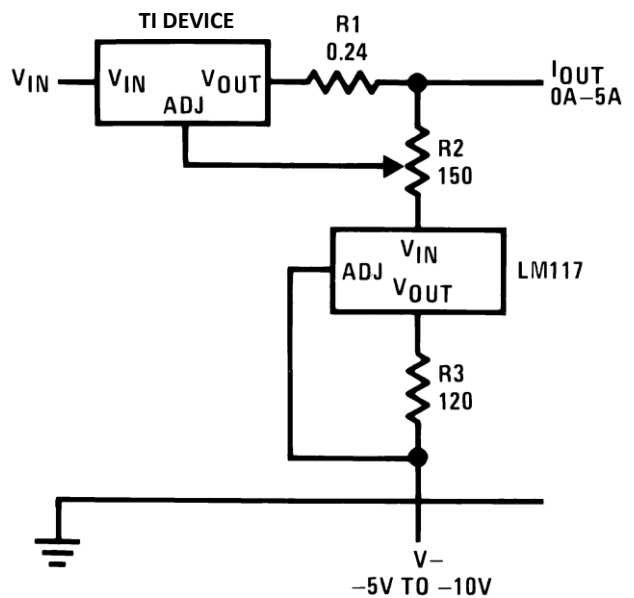
Figure 33. 0 to 22-V Regulator

System Examples (continued)



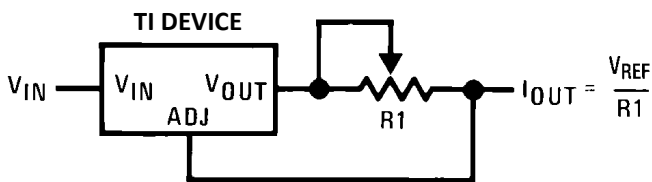
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Figure 34. 12-V Battery Charger



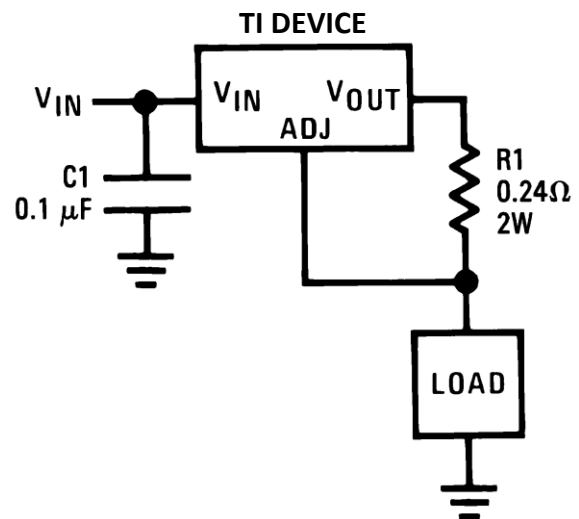
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Figure 35. Adjustable Current Regulator



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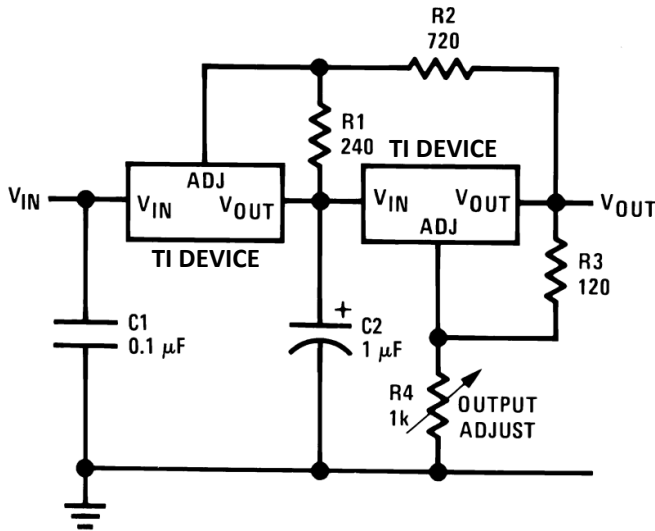
Figure 36. Precision Current Limiter



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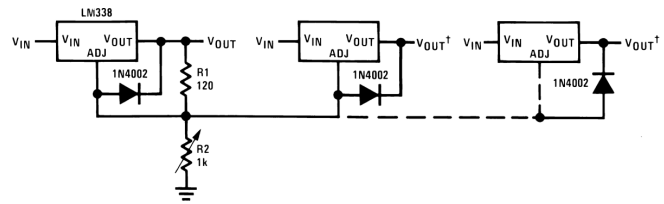
Figure 37. 5-A Current Regulator

System Examples (continued)



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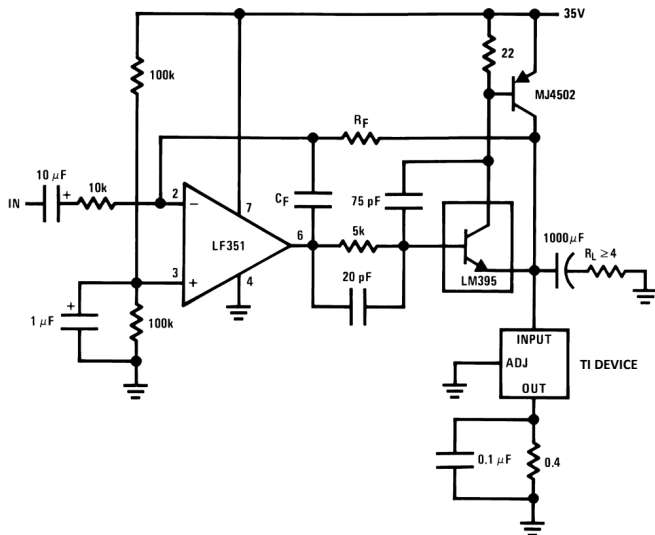
Figure 38. Tracking Preregulator



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† Minimum load—10 mA
* All outputs within ±100 mV

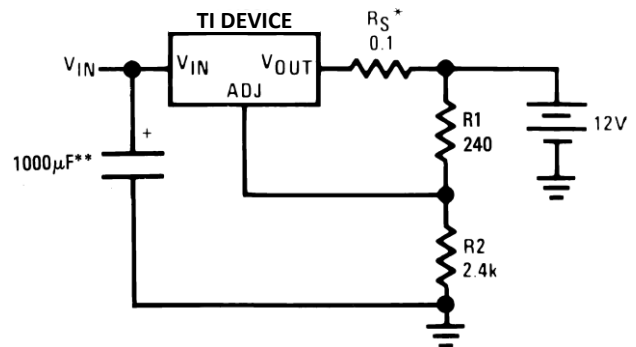
Figure 39. Adjusting Multiple On-Card Regulators With Single Control*



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$A_V = 1$, $R_F = 10k$, $C_F = 100$ pF
 $A_V = 10$, $R_F = 100k$, $C_F = 10$ pF
Bandwidth ≥ 100 kHz
Distortion $\leq 0.1\%$

Figure 40. Power Amplifier



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* R_S —sets output impedance of charger $Z_{OUT} = R_S \left(1 + \frac{R_2}{R_1} \right)$

Use of R_S allows low charging rates with fully charged battery.

**The 1000 μ F is recommended to filter out input transients

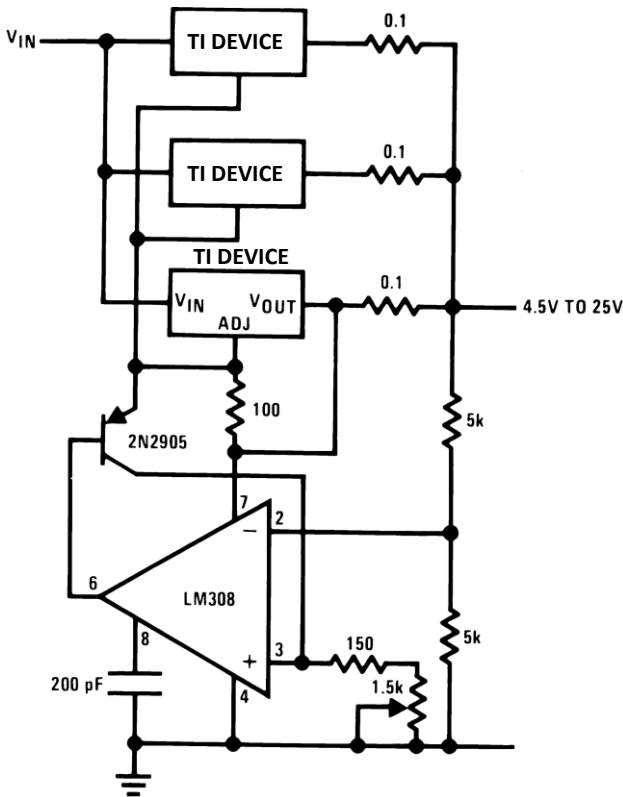
* R_S —sets output impedance of charger $Z_{OUT} = R_S \left(1 + \frac{R_2}{R_1} \right)$

Use of R_S allows low charging rates with fully charged battery.

**The 1000 μ F is recommended to filter out input transients

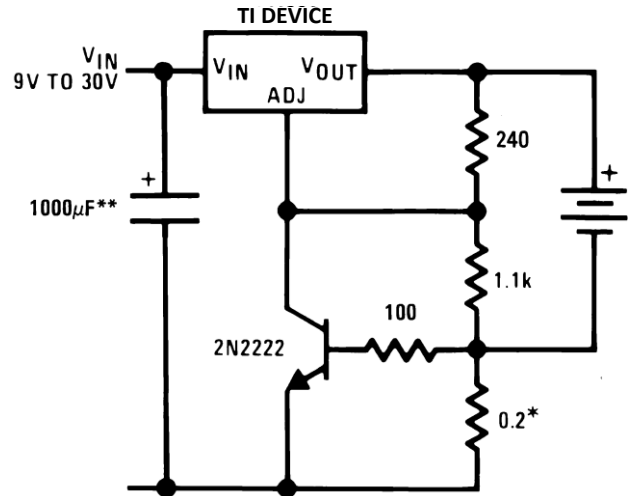
Figure 41. Simple 12-V Battery Charger

System Examples (continued)



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Figure 42. Adjustable 15-A Regulator

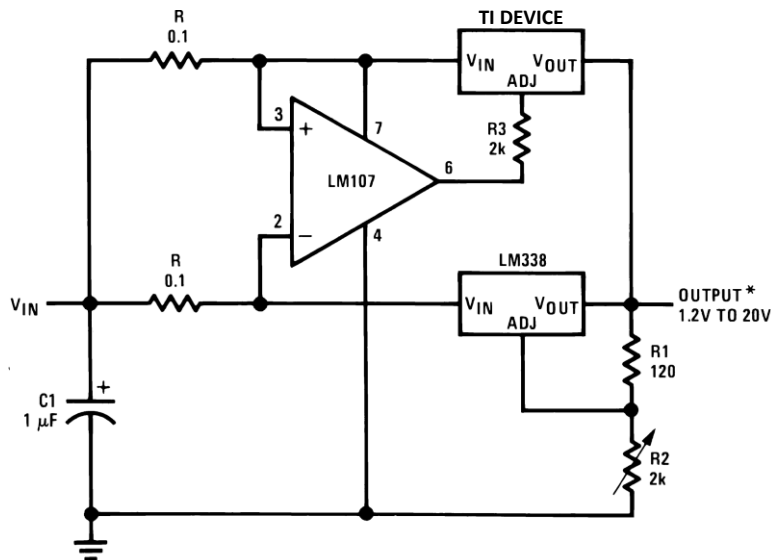


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* Set max charge current to 3 A

** THE 1000 μ F is recommended to filter out input transients.

Figure 43. Current Limited 6-V Charger



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* Minimum load—100 mA

Figure 44. 10-A Regulator

9 Power Supply Recommendations

The input supply to LM338 must be kept at a voltage level such that its maximum input to output differential voltage rating is not exceeded. The minimum dropout voltage must also be met with extra headroom when possible to keep the LM338 in regulation. TI recommends a capacitor be placed at the input to bypass noise.

10 Layout

10.1 Layout Guidelines

Some layout guidelines must be followed to ensure proper regulation of the output voltage with minimum noise. Traces carrying the load current must be wide to reduce the amount of parasitic trace inductance and the feedback loop from V_{OUT} to ADJ must be kept as short as possible. To improve PSRR, a bypass capacitor can be placed at the ADJ pin and must be placed as close as possible to the IC. In cases when V_{IN} shorts to ground, an external diode must be placed from V_{OUT} to V_{IN} to divert the surge current from the output capacitor and protect the IC. Similarly, in cases when a large bypass capacitor is placed at the ADJ pin and V_{OUT} shorts to ground, an external diode must be placed from ADJ to V_{OUT} to provide a path for the bypass capacitor to discharge. These diodes must be placed close to the corresponding IC pins to increase their effectiveness.

10.2 Layout Example

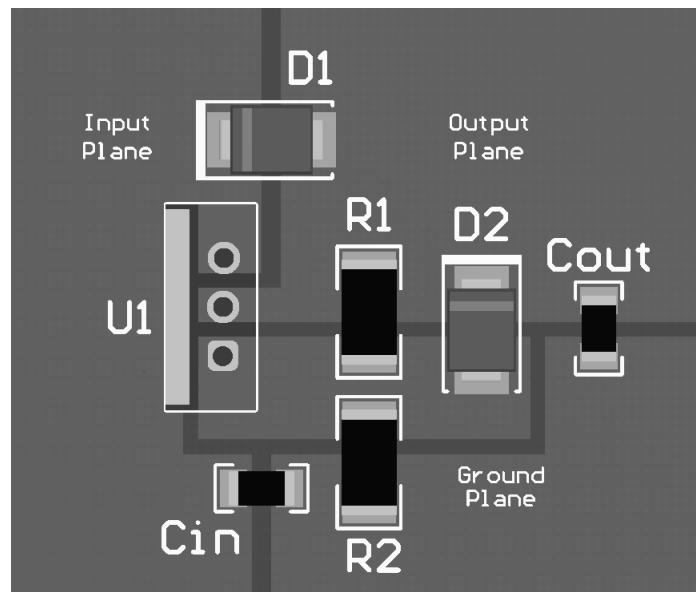


Figure 45. LMx38 Layout

11 Device and Documentation Support

11.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

11.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

11.3 Trademarks

E2E is a trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

11.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

11.5 Glossary



[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|-------------------|---------------|--------------|-----------------|------|-------------|----------------------|--------------------------------------|----------------------|--------------|-------------------------|---|
| LM338K STEEL | ACTIVE | TO-3 | NDS | 2 | 50 | Non-RoHS & Non-Green | Call TI | Call TI | 0 to 0 | LM338K STEELP+ |  |
| LM338K STEEL/NOPB | ACTIVE | TO-3 | NDS | 2 | 50 | RoHS & Green | Call TI | Level-1-NA-UNLIM | 0 to 0 | LM338K STEELP+ |  |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TRAY


Chamfer on Tray corner indicates Pin 1 orientation of packed units.

*All dimensions are nominal

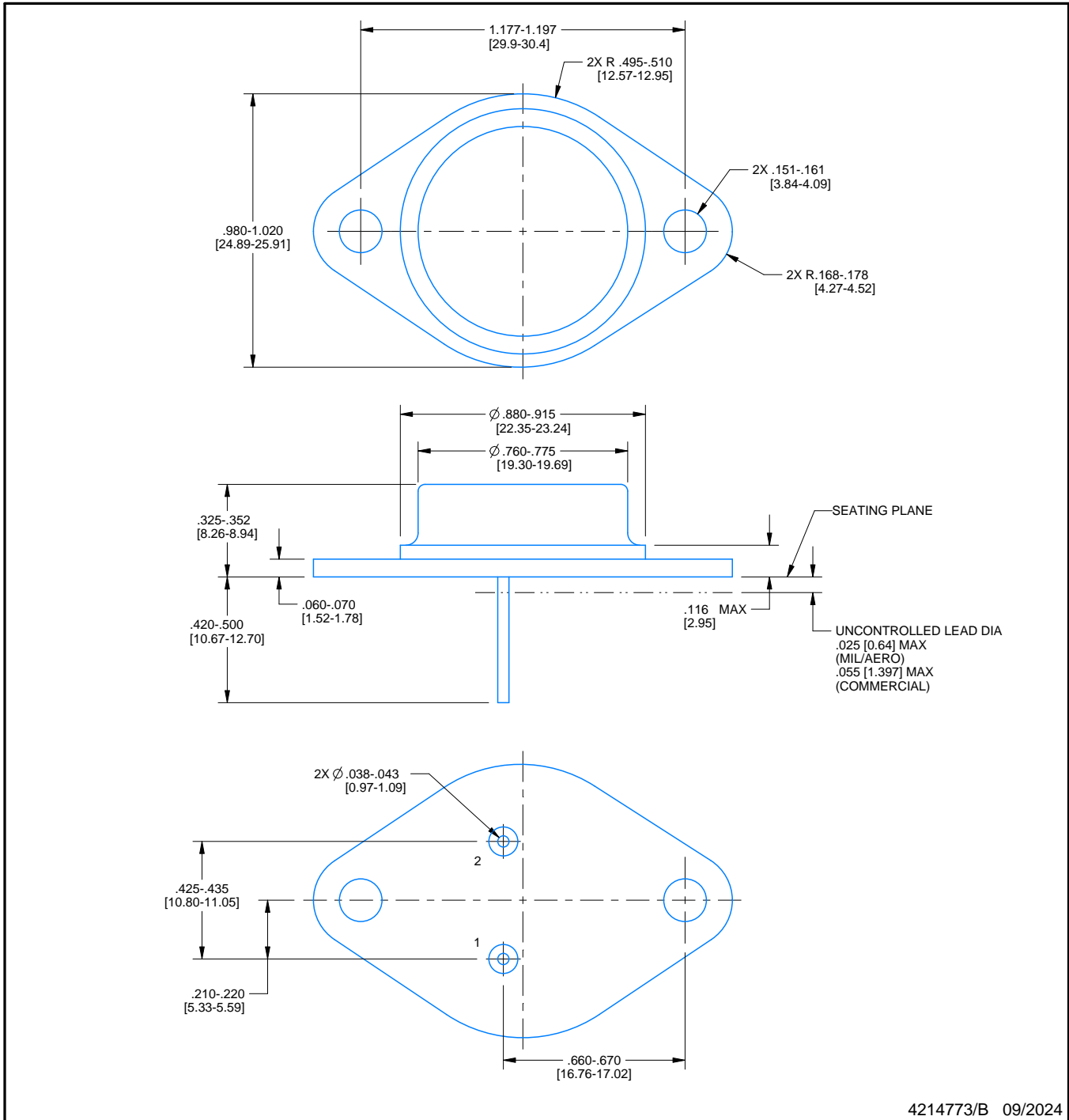
| Device | Package Name | Package Type | Pins | SPQ | Unit array matrix | Max temperature (°C) | L (mm) | W (mm) | K0 (µm) | P1 (mm) | CL (mm) | CW (mm) |
|-------------------|--------------|--------------|------|-----|-------------------|----------------------|--------|--------|---------|---------|---------|---------|
| LM338K STEEL | NDS | TO-CAN | 2 | 50 | 9 X 6 | NA | 292.1 | 215.9 | 25654 | 3.87 | 22.3 | 25.4 |
| LM338K STEEL/NOPB | NDS | TO-CAN | 2 | 50 | 9 X 6 | NA | 292.1 | 215.9 | 25654 | 3.87 | 22.3 | 25.4 |

NDS0002A



PACKAGE OUTLINE
TO-CAN - 8.94 mm max height

TRANSISTOR OUTLINE



4214773/B 09/2024

NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

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